

Degradation of Si-based detectors parameters under the alpha-particle irradiation S.V. Bakhlanov<sup>a</sup>, N.V. Bazlov<sup>a,b</sup>, A.V. Derbin<sup>a</sup>, I.S. Drachnev<sup>a</sup>, I.M. Kotina<sup>a</sup>, O.I. Konkov<sup>a,c</sup>, V.N. Muratova<sup>a</sup>, M.S. Mikulich<sup>a</sup>, <u>M.V. Trushin<sup>a</sup></u>, E.V. Unzhakov<sup>a</sup>

Corresponding author email: Trushin\_MV@pnpi.nrcki.ru

<sup>a</sup> NRC "Kurchatov Institute" - PNPI, Gatchina, Russia

<sup>b</sup> V.A.Fok Institute of Physics, St.Petersburg State University, St.Petersburg, Russia

<sup>c</sup> Ioffe Physical-Technical Institute of the Russian Academy of Sciences, St. Petersburg, Russia

#### **Motivation**

Semiconductor detectors are widely used in nuclear physics and high energy physics experiments. They possess unique characteristics for solving various experimental tasks – thin entrance window, good temporal and energy resolution. However, the application of semiconductor detectors could be limited by their ultimate radiation resistance.

Radiation defects in silicon are known to be electrically and recombination active. An increase of radiation defects concentration leads to significant

#### **Detectors description**

• Detector 1 - surface barrier detector: p-Si, boron doping ~  $5*10^{12}$  cm<sup>-3</sup> front surface – SiO<sub>2</sub> passivation layer (NAOS [2]) + Al barrier contact

rear surface – Pd ohmic contact

Sensitive area -  $\emptyset$  7.5 mm, thickness 0.7 mm Due to limited active region depth, suited for detection of particle with small penetration depth, such as  $\alpha$ -particles





degradation of the working parameters of semiconductor detectors. Thus, the investigation of radiation defects properties in order to enhance the radiation hardness of semiconductor detectors is an important task for successful implementation of a number of nuclear physics experiments.

## **Goal of the work**

Some previous experiments [1] suggest higher radiation resistance of p-type Si as compared to n-type Si, which is widely applied in detector production. Thus, in this work we planned

- to investigate the degradation of p-type Si based surface barrier and Si(Li) p-i-n detectors parameters during the long-termed irradiation by α-particles,
- to study the type and concentration of the radiation defects formed under αparticles irradiation.

# **As-prepared detectors**

Measurement conditions:

Detector 1: applied bias Ub=10V, active region width ~50  $\mu$ m (popetration donth of a particles in Si ~20  $\mu$ m)

(penetration depth of  $\alpha$ -particles in Si ~30  $\mu$ m)

reverse current at 10V  $Ir=0.3 \mu A$ 

Detector 2: Ub=400V corresponding to full depletion reverse current at 400V Ir=7.5  $\mu$ A

Detector 2 - Si(Li) p-i-n detector produced by Pell,s method:
p-Si, FZ, resistivity 4 kOhm\*cm, carrier lifetime 800 μs,
Sensitive area - Ø 13.5 mm, thickness 4.3 mm.
Suited for detection of particles with high penetration depth



- The spectrometric channel consists of BUI-3K amplifier with shaping time of 1-4  $\mu$ s and a 4000-channel 12-bit CAMAC ADC type 161.31 (produced by PNPI) with resolution of 1.7 keV/channel.
- Irradiation was performed at room temperature in vacuum by reference spectrometric source of  $\alpha$ -particles containing 233U, 238Pu and 239Pu isotopes with almost equal activities.

## **Irradiated detectors**

Detectors were irradiated during 8 weeks at room temperature in vacuum with counting rate of 2200-2400 cps up to a total dose:

11,0

10,5

Detector 1 - of  $8*10^9 \alpha$ -particles

Detector 2 - of  $6*10^9 \alpha$ -particles



Nearly linear increase of the reverse currents during irradiation up to: Detector 1: Ir=0.7 μA,



Resolution on as-prepared detectors: Detector 1 FWHM ~ 70 keV Detector 2 FWHM ~ 130 keV

Total FWHM is defined by:  $\sigma = \sigma_F^2 + \sigma_s^2 + \sigma_I^2 + \sigma_R^2 + \sigma_C^2$  where  $\sigma_F - Fano factor$ 

 $\sigma_s$  – losses in radiation source and detector's dead layer

 $\sigma_{I} \sim (\tau I)^{1/2}$  leakage current

 $\sigma_R \sim (\tau/Rc)^{1/2}$  and  $\sigma_R \sim C/(\tau)^{1/2}$  feedback resistance and capacitance

In our case the main contribution to the energy resolution is determined by  $\sigma_I$ , i.e. by the reverse current of the detector.

### **Summary**

• As a result of 8-weeks irradiation with a total dose of 6-8\*10<sup>9</sup>  $\alpha$ -particles, it



Resolution of irradiated detectors: Detector 1: FWHM ~ 100 keV Detector 2: FWHM ~ 160 keV

Resolution has degraded!

<sup>10,0</sup> slope  $\Delta I/\Delta \Phi \sim 1.5*10^{-16} \text{ A/(cm^2\alpha)}$ <sup>9,5</sup>  $\Delta \Delta \Phi$  Detector 2: Ir=9.5 μA, slope <sup>9,0</sup> slope  $\Delta I/\Delta \Phi \sim 2.7*10^{-16} \text{ A/(cm^2\alpha)}$ 

Increased reverse currents have resulted in resolution deterioration.



# **Characterization of radiation defects in Detector 1 by current-DLTS**



was established that increase of the reverse current is described by a linear function of fluence with the slopes  $\Delta I/\Delta \Phi = (1.5 - 2.7)*10^{-16} \text{ A}/(\text{cm}^2 \alpha)$ .

• Degradation of the energy resolution of  $\alpha$ -peaks is associated with increase of the detectorreverse current and could be described by  $\Delta\sigma/\Delta\Phi = (4-5)*10^{-9}$  keV/ $\alpha$ .

• It was established that a change in the energy resolution of the p-Si based detectors makes it possible to reliably separate the signals from  $\alpha$ -particles until the fluence of a few 10<sup>10</sup>  $\alpha$ -particles.

• Two deep traps were revealed in irradiated Detector 1 by iDLTS method. The concentration of the dominant Ev+0,55 eV traps of 3\*10<sup>13</sup> cm<sup>-3</sup> is high enough to explain the observed increase of the reverse current.





Two traps were revealed by iDLTS:

Ev+0.39 eV - close to the previously observed in  $\alpha$ -irradiated p-Si [3] [4] and ascribed to Ci-related radiation defect Ev+0.56 eV - resembles the defect observed in  $\alpha$ -irradiated p-Si [4] [5] and ascribed to unidentified radiation defect

**References** 

[1] T. Markvart, Journal of Materials Science: Materials in Electronics, 1, 1, (1990)
[2] Asuha et al, Applied Physics Letters 81, 3410 (2002)
[3] M. Asghar, M. Zafar Iqbal and N. Zafar, Journal of Applied Physics 73, 4240 (1993)

[4] Helga T. Danga et al, Physica B 535 (2018) 99–101[5] M. Mamor et al , Phys. Rev. B 63, 045201 (2000)

The work was funded by RFBR, project number 20-02-00571.